INTERNATIONAL STANDARD

IEC 60747-14-1

First edition 2000-10

Semiconductor devices -

Part 14-1:

Semiconductor sensors – General and classification

Dispositifs à semiconducteurs –

Partie 14-1:

Capteurs à semiconducteurs – Généralités et classification

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PRICE CODE



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INTERNATIONAL ELECTROTECHNICAL COMMISSION

SEMICONDUCTOR DEVICES -

Part 14-1: Semiconductor sensors – General and classification

FOREWORD

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International Standard IEC 60747-14 has been prepared by subcommittee 47E: Discrete semiconductor devices, of IEC technical committee 47: Semiconductor devices.

The text of this standard is based on the following documents:

FDIS Report on voting			
1 Die Tiepert ein Verling	FDIS	Report on voting	
47E/157/FDIS 47E/170/RVD	47E/157/F	DIS 47E/170/RVD	

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 3.

The committee has decided that the contents of this publication remain unchanged until 2005. At this date, the publication will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

A bilingual version of this standard may be issued at a later date.

INTRODUCTION

This part of IEC 60747 should be read in conjunction with IEC 60747-1. It provides basic information on semiconductor

- terminology;
- letter symbols;
- essential ratings and characteristics;
- measuring methods;
- acceptance and reliability.

